











UC1846, UC1847, UC2846 UC2847, UC3846, UC3847

SLUS352C - JANUARY 1997-REVISED DECEMBER 2015

# **UCx846/7 Current Mode PWM Controller**

#### **Features**

- **Automatic Feedforward Compensation**
- Programmable Pulse-by-Pulse Current Limiting
- Automatic Symmetry Correction in Push-Pull Configuration
- **Enhanced Load Response Characteristics**
- Parallel Operation Capability for Modular Power
- Differential Current Sense Amplifier with Wide Common Mode Range
- **Double-Pulse Suppression**
- 500-mA (Peak) Totem-pole Outputs
- ±1% Band Gap Reference
- Undervoltage Lockout
- Soft-Start Capability
- Shutdown Terminal
- 500-kHz Operation

# **Applications**

- **Telecommunication Power Converters**
- Industrial Power Converters

## 3 Description

The UC1846/7 family of control devices provides all of the necessary features to implement fixedfrequency, current-mode control schemes while maintaining a minimum external parts count. The superior performance of this technique can be measured in improved line regulation, enhanced load response characteristics, and a simpler, easier-todesign control loop. Topological advantages include inherent pulse-by-pulse current limiting capability, automatic symmetry correction for push-pull converters, and the ability to parallel power modules while maintaining equal current sharing.

Protection circuitry includes built-in undervoltage lockout and programmable current limit, in addition to soft-start capability. A shutdown function is also available, which can initiate either a complete shutdown with automatic restart or latch the supply off.

Other features include fully-latched operation, doublepulse suppression, deadline adjust capability, and a ±1% trimmed band gap reference.

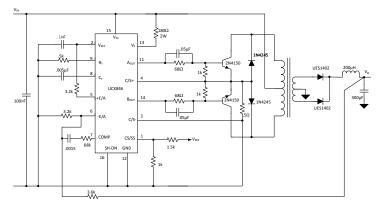
The UC1846 features low outputs in the OFF state, while the UCx847 features high outputs in the OFF state.

#### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
UC1846	LCCC (20)	8.89 mm × 8.89 mm
001646	CDIP (16)	6.92 mm × 19.56 mm
	PLCC (20)	8.96 mm × 8.96 mm
UC2846, UC3846	SOIC (16)	7.5 mm × 10.3 mm
	PDIP (16)	6.35 mm × 19.3 mm
1100047 1100047	SOIC (16)	7.5 mm × 10.3 mm
UC2847, UC3847	PDIP (16)	6.35 mm × 19.3 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

#### **Block Diagram**





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## 4 Revision History

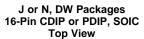
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

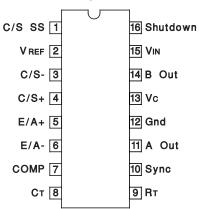
# Changes from Revision B (July 2010) to Revision C Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section. Removed soldering temperature Changes from Revision A (February 2002) to Revision B Page Updated Block Diagram.

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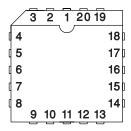


# 5 Pin Configuration and Functions





#### FN or FK Packages 20-Pin PLCC or LCCC Top View



#### **Pin Functions**

	DIN									
	PIN									
DIL, SOIC NO.	PLCC, LCC NO.	NAME	I/O	DESCRIPTION						
1	2	C/S SS	I	Current limit/soft-start programming						
2	3	$V_{REF}$	0	5.1-V reference voltage output						
3	4	C/S -	I	Current sense comparator inverting input						
4	5	C/S +	I	Current sense comparator non-inverting input						
5	7	E/A +	I	Error amplifier inverting input						
6	8	E/A -	1	Error amplifier inverting input						
7	9	COMP	I/O	Error amplifier output and input to the PWM comparator						
8	10	C <sub>T</sub>	1	Oscillator frequency programming capacitor pin						
9	12	C <sub>R</sub>	I	Oscillator frequency programming resistor pin						
10	13	Sync	I/O	Synchronization out from master controller or input of slave controller						
11	14	A Out	0	PWM drive signal output A, Pin11 and P14 are complementary						
12	15	GND	G	All signals are referenced to this node						
13	17	$V_{C}$	I	Bias supply input for output stage						
14	18	B Out	0	PWM drive signal output B, Pin11 and P14 are complementary						
15	19	V <sub>IN</sub>	1	Bias supply input						
16	20	Shutdown	I	External shutdown signal input						
_	1, 6, 11, 16	N/C								



## 6 Specifications

#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

	MIN	MAX	UNIT
Supply Voltage (Pin 15)		40	V
Collector Supply Voltage (Pin 13)		40	V
Output Current, Source or Sink (Pins 11, 14)		500	mA
Analog Inputs (Pins 3, 4, 5, 6, 16)	-0.3	+V <sub>IN</sub>	V
Reference Output Current (Pin 2)		-30	mA
Sync Output Current (Pin 10)		-5	mA
Error Amplifier Output Current (Pin 7)		-5	mA
Soft Start Sink Current (Pin 1)		50	mA
Oscillator Charging Current (Pin 9)		5	mA
Power Dissipation at T <sub>A</sub> = 25°C		1000	mW
Power Dissipation at T <sub>C</sub> = 25°C		2000	mW
Storage temperature, T <sub>stq</sub>	<b>–</b> 65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

			VALUE	UNIT
	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±2500		
V <sub>(ESD)</sub>	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±1500	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	•	<b>U</b> (	,				
				MIN	NOM	MAX	UNIT
VR	EF terminal exter	nal capacitance		1		2.2	μF

#### 6.4 Thermal Information

		UCx	UCx846/7			
	THERMAL METRIC <sup>(1)</sup>	N or DW (PDIP or SOIC)	J or DW (CDIP or SOIC)	UNIT		
		16 PINS	16 PINS			
$R_{\theta JA}$	Junction-to-ambient thermal resistance	41.8	73.1	°C/W		
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	28.5	34.2	°C/W		
$R_{\theta JB}$	Junction-to-board thermal resistance	21.8	38.0	°C/W		
$\Psi_{JT}$	Junction-to-top characterization parameter	13.0	7.7	°C/W		
ΨЈВ	Junction-to-board characterization parameter	21.7	37.4	°C/W		
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	N/A	N/A	°C/W		

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

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<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



### 6.5 Electrical Characteristics

 $T_A$ =-55°C to +125°C for UC1846/7; -40°C to +85°C for the UC2846/7; and 0°C to +70°C for the UC3846/7;  $V_{IN}$ =15 V,  $R_T$ =10k,  $C_T$ =4.7 nF,  $T_A$ = $T_L$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS		C1846/7 C2846/7		UC3846/7			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
REFERENCE								
Output Voltage	$T_J = 25^{\circ}C, I_O = 1 \text{ mA}$	5.05	5.10	5.15	5.00	5.10	5.20	V
Line Regulation	V <sub>IN</sub> = 8 V to 40 V		5	20		5	20	mV
Load Regulation	I <sub>L</sub> = 1 mA to 10 mA		3	15		3	15	mV
Temperature Stability	Over Operating Range, (1)		0.4			0.4		mV/°C
Total Output Variation	Line, Load, and Temperature <sup>(1)</sup>	5.00		5.20	4.95		5.25	V
Output Noise Voltage	10 Hz ≤ f ≤10 kHz, T <sub>J</sub> = 25°C <sup>(1)</sup>		100			100		μV
Long Term Stability	T <sub>J</sub> = 125°C, 1000 Hrs <sup>(1)</sup>		5			5		mV
Short Circuit Output Current	V <sub>REF</sub> = 0 V	-10	-45		-10	-45		mA
OSCILLATOR				<u> </u>				
Initial Accuracy	$T_J = 25^{\circ}C$	39	43	47	39	43	47	kHz
Voltage Stability	V <sub>IN</sub> =8 V to 40 V		-1%	2%		-1%	2%	
Temperature Stability	Over Operating Range <sup>(1)</sup>		-1%			-1%		
Sync Output High Level		3.9	4.35		3.9	4.35		V
Sync Output Low Level			2.3	2.5		2.3	2.5	V
Sync Input High Level	Pin 8 = 0 V	3.9			3.9			V
Sync Input Low Level	Pin 8 = 0 V			2.5			2.5	V
Sync Input Current	Sync Voltage = 3.9 V, Pin 8 = 0 V		1.3	1.5		1.3	1.5	mA
ERROR AMPLIFIER								
Input Offset Voltage			0.5	5		0.5	10	mV
Input Bias Current			-0.6	-1		-0.6	-2	μΑ
Input Offset Current			40	250		40	250	nA
Common Mode Range	$V_{IN} = 8 \text{ V to } 40 \text{ V}$	0		V <sub>IN</sub> - 2 V	0		V <sub>IN</sub> - 2 V	V
Open Loop Voltage Gain	$\Delta V_{O} = 1.2 \text{ to } 3 \text{ V}, \text{ V}_{CM}$ = 2 V	80	105		80	105		dB
Unity Gain Bandwidth	$T_J = 25^{\circ}C^{(1)}$	0.7	1.0		0.7	1.0		MHz
CMRR	$V_{CM} = 0 \text{ V to } 38 \text{ V},$ $V_{IN} = 40 \text{ V}$	75	100		75	100		dB
PSRR	$V_{IN} = 8 V to 40 V$	80	105		80	105		dB
Output Sink Current	$V_{ID} = -15 \text{ mV to } -5 \text{ V},$ $V_{PIN7} = 1.2 \text{ V}$	2	6		2	6		mA
Output Source Current	$V_{ID} = 15 \text{ mV to -5 V},$ $V_{PIN7} = 2.5 \text{ V}$	-0.4	-0.5		-0.4	-0.5		mA
High Level Output Voltage	$R_L = (Pin 7) 15 k\Omega$	4.3	4.6		4.3	4.6		V
Low Level Output Voltage	$R_L$ = (Pin 7) 15 kΩ		0.7	1		0.7	1	V
CURRENT SENSE AMPLIFIE	ER .							
Amplifier Gain	V <sub>PIN 3</sub> = 0 V, Pin 1 Open <sup>(2)</sup> , <sup>(3)</sup>	2.5	2.75	3.0	2.5	2.75	3.0	V

<sup>(1)</sup> These parameters, although ensured over the recommended operating conditions, are not 100% tested in production.

<sup>(2)</sup> Parameter measured at trip point of latch with VPIN 5 = VREF, VPIN 6 = 0 V.

<sup>(3)</sup> Amplifier gain defined as:  $G = \Delta V_{PIN7} / \Delta V_{PIN4}$ ;  $V_{PIN4} = 0$  to 1.0 V



## **Electrical Characteristics (continued)**

 $T_A$ =-55°C to +125°C for UC1846/7; -40°C to +85°C for the UC2846/7; and 0°C to +70°C for the UC3846/7;  $V_{IN}$ =15 V,  $R_T$ =10k,  $C_T$ =4.7 nF,  $T_A$ = $T_J$  (unless otherwise noted)

PARAMETER $PARAMETER$	TEST CONDITIONS	UC	C1846/7 C2846/7		U	C3846/7		UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
Maximum Differential Input Signal (V <sub>PIN 4</sub> -V <sub>PIN 3</sub> )	Pin 1 Open <sup>(2)</sup> ; R <sub>L</sub> (Pin 7) = 15 kW	1.1	1.2		1.1	1.2		V
Input Offset Voltage	V <sub>PIN 1</sub> = 0.5 V, Pin 7 Open <sup>(2)</sup>		5	25		5	25	mV
CMRR	V <sub>CM</sub> = 1 V to 12 V	60	83		60	83		dB
PSRR	$V_{IN} = 8 \text{ V to } 40 \text{ V}$	60	84		60	84		dB
Input Bias Current	$V_{PIN 1} = 0.5 \text{ V, Pin 7}$ Open <sup>(2)</sup>		-2.5	-10		-2.5	-10	μΑ
Input Offset Current	$V_{PIN 1} = 0.5 \text{ V}, \text{ Pin 7}$ Open <sup>(2)</sup>		0.08	1		0.08	1	μΑ
Input Common Mode Range		0		V <sub>IN</sub> -3	0		V <sub>IN</sub> -3	V
Delay to Outputs	$T_J = 25^{\circ}C^{(1)}$		200	500		200	500	ns
CURRENT LIMIT ADJUST								
Current Limit Offset	V <sub>PIN 3</sub> = 0 V, V <sub>PIN 4</sub> = 0 V, Pin 7 Open (2)	0.45	0.5	0.55	0.45	0.5	0.55	V
Input Bias Current	$V_{PIN 5} = V_{REF}, V_{PIN 6}$ = 0 V		-10	-30		-10	-30	μΑ
SHUTDOWN TERMINAL								
Threshold Voltage		250	350	400	250	350	400	mV
Input Voltage Range		0		V <sub>IN</sub>	0		$V_{IN}$	V
Minimum Latching Current (I <sub>PIN1</sub> )		<sup>(4)</sup> 3.0	1.5		3.0	1.5		mA
Maximum Latching Current (I <sub>PIN1</sub> )			<sup>(5)</sup> 1.5	0.8		1.5	8.0	mA
Delay to Outputs	$T_J = 25^{\circ}C^{(1)}$		300	600		300	600	ns
OUTPUT								
Collector-Emitter Voltage		40			40			V
Collector Leakage Current	$V_C = 40 \ V^{(6)}$			200			200	μΑ
Output Lauri aval	I <sub>SINK</sub> = 20 mA		0.1	0.4		0.1	0.4	>
Output Low Level	I <sub>SINK</sub> = 100 mA		0.4	2.1		0.4	2.1	V
Outrot High Lavel	I <sub>SOURCE</sub> = 20 mA	13	13.5		13	13.5		٧
Output High Level	I <sub>SOURCE</sub> = 100 mA	12	13.5		12	13.5		V
Rise Time	$C_L = 1 \text{ nF, } T_J = 25^{\circ}\text{C}$		50	300		50	300	ns
Fall Time	$C_{L} = 1 \text{ nF, } T_{J} = 25^{\circ}\text{C}$		50	300		50	300	ns
UNDERVOLTAGE LOCKOUT				-				
Start-Up Threshold			7.7	8.0		7.7	8.0	V
Threshold Hysteresis			0.75			0.75		V
TOTAL STANDBY CURRENT	1							
Supply Current			17	21		17	21	mA

<sup>(4)</sup> Current into Pin 1 ensured to latch circuit in shutdown state.

<sup>(5)</sup> Current into Pin 1 ensured not to latch circuit in shutdown state.

<sup>(6)</sup> Applies to UC1846/UC2846/UC3846 only due to polarity of outputs.



# 6.6 Typical Characteristics

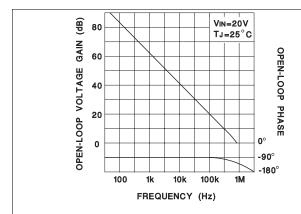


Figure 1. Error Amplifier Gain and Phase vs Frequency

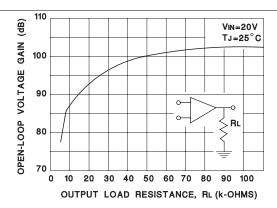


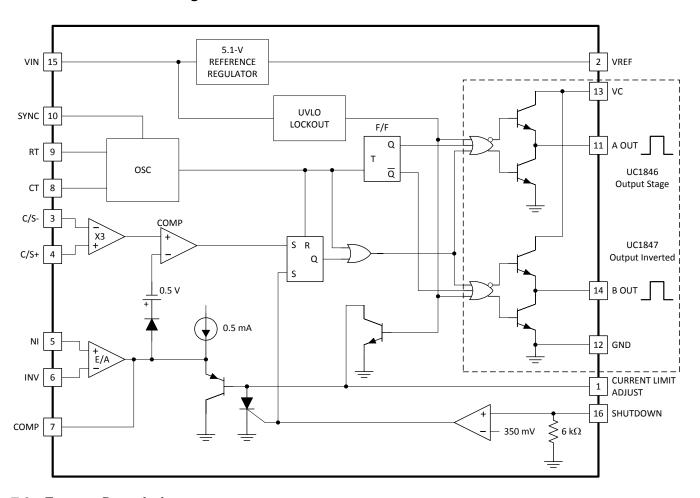
Figure 2. Error amplifier Open-Logic DC Gain vs Load Resistance

## 7 Detailed Description

#### 7.1 Overview

The UCx846/7 family of control devices provides the necessary features to implement off-line or DC-to-DC fixed-frequency, current-mode control schemes with a minimal external parts count. Internally implemented circuits include under-voltage lockout featuring start-up current less than 1 mA, a precision reference trimmed for accuracy at the error amplifier input, logic to insure latched operation, a PWM comparator which also provides current limit control, and a totem pole output stage designed to source or sink high-peak current. The output stage, suitable for driving either N-Channel MOSFETs or bipolar transistor switches, is low in the off state.

#### 7.2 Functional Block Diagram



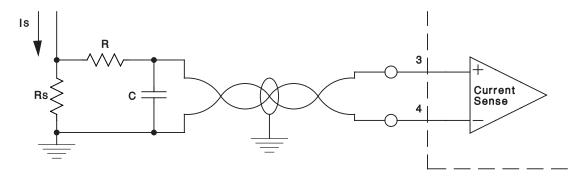
## 7.3 Feature Description

#### 7.3.1 Current Sense Amplifier

The current sense amplifier may be used in a variety of ways to sense peak switch current for comparison with an error voltage. Referring to *Functional Block Diagram*, maximum swing on the inverting input of the PWM comparator is limited to approximately 3.5 V by the internal regulated supply. Accordingly, for a fixed gain of 3, maximum differential voltages must be kept below 1.2 V at the current sense inputs.



#### **Feature Description (continued)**



A small RC filter may be required in some applications to reduce switch transients. Differential input allows remote, noise free sensing.

Figure 3. Current Sense Amplifier Connection

#### 7.3.2 Oscillator

By implementing the oscillator using all NPN transistors, the UCx846/7 achieves excellent temperature stability and waveform clarity at frequencies in excess of 1 MHz.

Referring to Figure 4, an external resistor  $R_T$  is used to generate a constant current into a capacitor  $C_T$  to produce a linear sawtooth waveform. Oscillator frequency may be approximated by selecting  $R_T$  and  $C_T$  such that:

$$f_{OSC} = \frac{2.2}{R_T C_T} \tag{1}$$

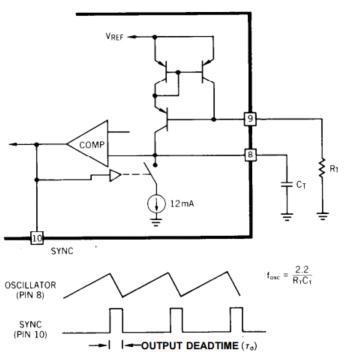


Figure 4. Oscillator Circuit



#### 7.4 Device Functional Modes

#### 7.4.1 Current Limit

One of the most attractive features of a current-mode converter is the ability to limit peak-switch currents on a pulse-by-pulse basis by simply limiting the error voltage to a maximum value.

#### 7.4.2 Shutdown

The shutdown circuit was designed to provide a fast acting general purpose shutdown port for use in implementing both protection circuitry and remote shutdown functions. The circuit may be divided into an input section consisting of a comparator with a 350-mV temperature compensated offset, and an output section consisting of a three transistor latch. Shutdown is accomplished by applying a signal greater than 350 mV to pin 16, causing the output latch to fire, and setting the PWM latch to provide an immediate signal to the outputs.

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## 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

The UCx846/7 family of control devices provides all of the necessary features to implement fixed frequency, current mode control schemes while maintaining a minimum external parts count. The superior performance of this technique can be measured in improved line regulation, enhanced load response characteristics, and a simpler, easier to design control loop. Topological advantages include inherent pulse-by-pulse current limiting capability, automatic symmetry correction for push-pull converters. Protection circuitry includes undervoltage lockout and programmable current limit in addition to soft-start capability. A shutdown function is also available which initiates either a complete shutdown with automatic restart or latch the supply off.

#### 8.2 Typical Application

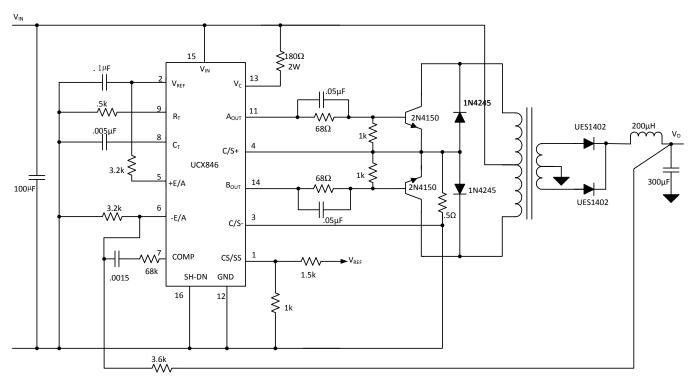


Figure 5. Typical Application Diagram

## 8.2.1 Design Requirements

Table 1 shows the design parameters for this application.

**Table 1. Design Parameters** 

DESIGN PARAMETER	TARGET VALUE
Typical efficiency	85%
Switching frequency	880 kHz
Pulse by pulse current limit threshold	1 A



#### 8.2.2 Detailed Design Procedure

This section details the design procedure based on the design requirements.

### 8.2.2.1 Design Switching Frequency

Output deadtime is determined by the external capacitor,  $C_T$ , according to the formula:

$$Td(\mu s) = 145 C_T (\mu F) \left[ \frac{ID}{ID - \frac{3.6}{RT(k\Omega)}} \right]$$

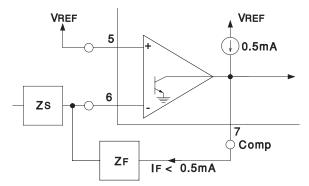
where

For large values of R<sub>T</sub>: τd (μs ) ≈145CT (μF).

Oscillator frequency is approximated by the formula:

$$fT(kHz) \approx \frac{2.2}{\left(R_T(k\Omega) \times C_T(\mu F)\right)}$$
(3)

#### 8.2.2.2 Error Amplifier Output Configuration

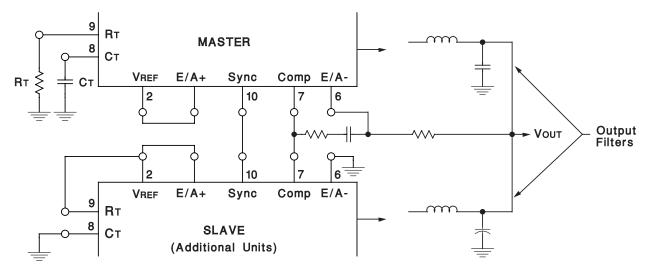


Error Amplifier can source up to 0.5mA.

Figure 6. Error Amplifier Output Configuration



#### 8.2.2.3 Parallel Operation Configuration



Slaving allows parallel operation of two or more units with equal current sharing.

Figure 7. Parallel Operation

## 8.2.2.4 Design Pulse by Pulse Current Limit Threshold

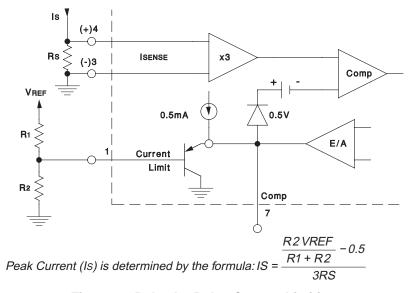


Figure 8. Pulse by Pulse Current Limiting



#### 8.2.2.5 Soft-Start and Shutdown, Restart Function Design

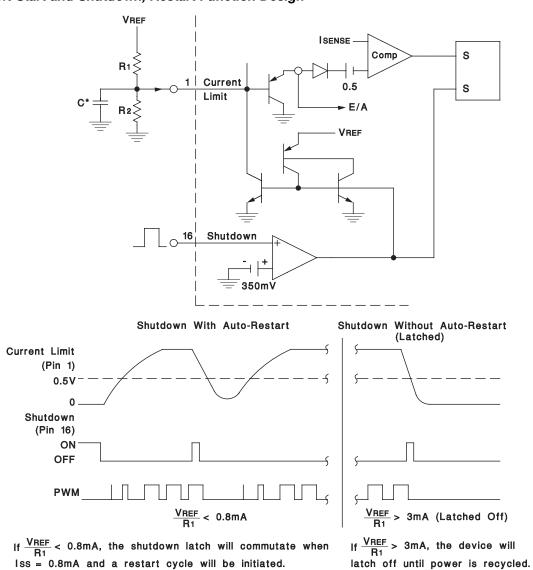
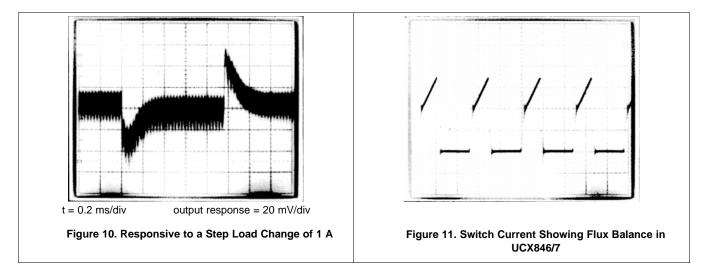


Figure 9. Soft-Start and Shutdown, Restart Functions



#### 8.2.3 Application Curves



# 9 Power Supply Recommendations

The VIN power terminal for the device requires the placement of low esr noise-decoupling capacitance as directly as possible from the VIN terminal to the GND terminal. Ceramic capacitors with stable dielectric characteristics over temperature are recommended, such as X7R or better.

The VC power terminal for the device requires the placement of resistance as directly as possible from the VC terminal to the VIN terminal.



## 10 Layout

#### 10.1 Layout Guidelines

- Place a low ESR and ESL decoupling capacitor C<sub>REF</sub> in the 1-μF to 2.2-μF range, preferably ceramic, from VREF pin to GND.
- The EA+ is a non-inverting input, the EA- is an inverting input and the COMP is the output of the error amplifier. Place resistor and capacitor series network between EA+ pin and COMP pin, and reduce the trace of resistor and capacitor series network as much as possible.
- Place a low ESR and ESL capacitor C<sub>T</sub>, preferably ceramic, from CT pin to GND, and place C<sub>T</sub> close to UCx846/7 as much as possible.
- Place a resistor R<sub>T</sub> from RT pin to GND, and place R<sub>T</sub> close to UCx846/7 as much as possible.

## 10.2 Layout Example

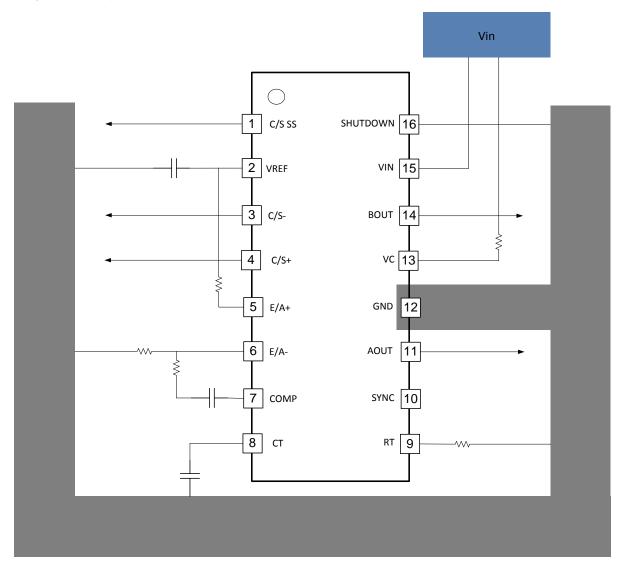


Figure 12. UCx84x Layout Example



## 11 Device and Documentation Support

#### 11.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 2. Related Links

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
UC1846	Click here	Click here	Click here	Click here	Click here
UC1847	Click here	Click here	Click here	Click here	Click here
UC2846	Click here	Click here	Click here	Click here	Click here
UC2847	Click here	Click here	Click here	Click here	Click here
UC3846	Click here	Click here	Click here	Click here	Click here
UC3847	Click here	Click here	Click here	Click here	Click here

## 11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community T's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 11.3 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

#### 11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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# **PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
5962-86806012A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 86806012A UC1846L/ 883B
5962-8680601EA	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8680601EA UC1846J/883B
UC1846J	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1846J
UC1846J.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1846J
UC1846J883B	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8680601EA UC1846J/883B
UC1846J883B.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8680601EA UC1846J/883B
UC1846L883B	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 86806012A UC1846L/ 883B
UC1846L883B.A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 86806012A UC1846L/ 883B
UC2846DW	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2846DW
UC2846DW.A	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2846DW
UC2846DWG4	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2846DW
UC2846DWTR	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2846DW
UC2846DWTR.A	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2846DW
UC2846J	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-40 to 85	UC2846J
UC2846J.A	Active	Production	CDIP (J)   16	25   TUBE	No	SNPB	N/A for Pkg Type	-40 to 85	UC2846J
UC2846N	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	UC2846N
UC2846N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	UC2846N
UC2846NG4	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	UC2846N
UC3846DW	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3846DW
UC3846DW.A	Active	Production	SOIC (DW)   16	40   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3846DW



0 to 70

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UC3847DW



UC3847DW

www.ti.com

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
UC3846DWTR	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3846DW
UC3846DWTR.A	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3846DW
UC3846DWTRG4	Active	Production	SOIC (DW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3846DW
UC3846N	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	UC3846N
UC3846N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	UC3846N
UC3846NG4	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	UC3846N

Call TI

Call TI

Obsolete

Production

SOIC (DW) | 16

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



# PACKAGE OPTION ADDENDUM

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#### OTHER QUALIFIED VERSIONS OF UC1846, UC2846, UC2846M, UC3846:

● Catalog : UC3846, UC2846

● Enhanced Product : UC1846-EP, UC1846-EP

• Military : UC2846M, UC1846

● Space : UC1846-SP, UC1846-SP

#### NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

# **PACKAGE MATERIALS INFORMATION**

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## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2846DWTR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
UC3846DWTR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

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## \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC2846DWTR	SOIC	DW	16	2000	353.0	353.0	32.0
UC3846DWTR	SOIC	DW	16	2000	353.0	353.0	32.0

# **PACKAGE MATERIALS INFORMATION**

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## **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-86806012A	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1846L883B	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1846L883B.A	FK	LCCC	20	55	506.98	12.06	2030	NA
UC2846DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC2846DW.A	DW	SOIC	16	40	507	12.83	5080	6.6
UC2846DWG4	DW	SOIC	16	40	507	12.83	5080	6.6
UC2846N	N	PDIP	16	25	506	13.97	11230	4.32
UC2846N.A	N	PDIP	16	25	506	13.97	11230	4.32
UC2846NG4	N	PDIP	16	25	506	13.97	11230	4.32
UC3846DW	DW	SOIC	16	40	507	12.83	5080	6.6
UC3846DW.A	DW	SOIC	16	40	507	12.83	5080	6.6
UC3846N	N	PDIP	16	25	506	13.97	11230	4.32
UC3846N.A	N	PDIP	16	25	506	13.97	11230	4.32
UC3846NG4	N	PDIP	16	25	506	13.97	11230	4.32

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